

Continental Device India Limited An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company





TO-92 Plastic Package For Lead Free Parts, Devi

For Lead Free Parts, Device Part # will be Prefixed with "T"

High Voltage Transistors

ABSOLUTE MAXIMUM RATINGS

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Base Voltage	V _{CBO}	300	V
Collector Emitter Voltage	V _{CEO}	300	V
Emitter Base Voltage	V _{EBO}	5.0	V
Collector Current Continuous	Ι _C	500	mA
Power Dissipation at T _a =25 ^o C	P _D	625	mW
Derate Above 25°C		5.0	mW/ºC
Power Dissipation at T _c =25 ^o C	P _D	1.5	W
Derate Above 25°C		12	mW/ºC
Operating And Storage Junction Temperature Range	T _j , T _{stg}	- 55 to +150	٥C

THERMAL CHARACTERISTICS

Junction to Case	R _{th (j-c)}	83.3	°C/W
Junction to Ambient in free air	R _{th (j-a)}	200	°C/W

ELECTRICAL CHARACTERISTICS (T_a=25^oC unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Collector Emitter Voltage	V _{CEO}	I _C =1mA, I _B =0	300		V
Collector Base Voltage	V _{CBO}	I _C =100μΑ, I _E =0	300		V
Emitter Base Voltage	V _{EBO}	I _E =100μΑ, I _C =0	5.0		V
Collector Cut Off Current	I _{CBO}	V _{CB} =200V, I _E =0,		250	nA
Emitter Cut Off Current	I _{EBO}	V _{EB} =3V, I _C =0,		100	nA
DC Current Gain	*h _{FE}	V _{CE} =10V, I _C =1mA	25		
		V _{CE} =10V, I _C =10mA	40		
		V _{CE} =10V, I _C =30mA	25		
Collector Emitter Saturation Voltage	*V _{CE (sat)}	I _C =20mA, I _B =2mA		0.5	V
Base Emitter Saturation Voltage	*V _{BE (sat)}	I _C =20mA, I _B =2mA		0.9	V

DYNAMIC CHARACTERISTICS

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Current Gain Bandwidth Product	f _T	I _C =10mA, V _{CE} =20V, f=100MHz	50		MHz
Collector Base Capacitance	C _{cb}	V _{CB} =20V, I _E =0, f=1MHz		6.0	pF

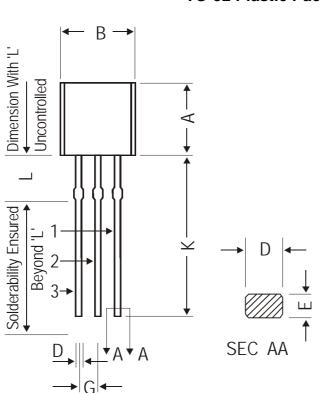
*PulseTest: Pulse Width <300ms, Duty Cycle<2% MPSA92Rev_1 071105E



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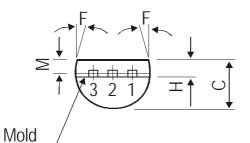
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TO-92 F	Plastic	Package
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DIM	MIN.	MAX.
А	4.32	5.33
В	4.45	5.20
С	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 D	EG
G	1.14	1.40
Н	1.20	1.40
К	12.70	
L	1.982	2.082
М	1.03	1.20

All dimensions are in mm



PIN CONFIGURATION 1. COLLECTOR 2. BASE 3. EMITTER

The TO-92 Package, Tape and Ammo Pack Drawings are correct as on the date of issue/revision of this Data Sheet. The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

Packing Details

PACKAGE	STANDARDPACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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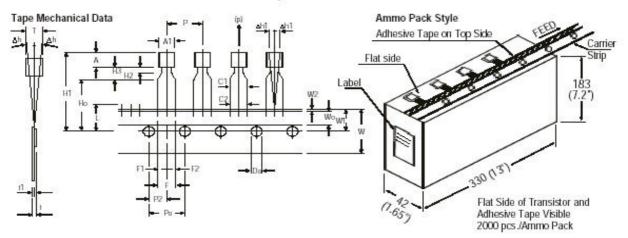
Parting Line

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TO-92 Tape and Ammo Pack



All dimensions are in mm

ITEM		SPECIFICATION			
	SYMBOL	MIN.	NOM.	MAX.	TOL.
BODY WIDTH	A1	4.45		5.20	
BODY HEIGHT	Α	4.32		5.33	
BODY THICKNESS	Т	3.18		4.19	
PITCH OF COMPONENT	Р		12.7		± 1.0
*1FEED HOLE PITCH	Po		12.7		± 0.3
*2 FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		± 0.4
DISTANCE BETWEEN OUTER LEADS	E		5.08		+ 0.6 - 0.2
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0	
*4 COMPONENT ALIGNMENT FRONT VIEW	Δh1		0	1.3	
TAPE WIDTH	W		18	0.000	± 0.5
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2
HOLE POSITION	W1		9		+ 0.7
HOLD-DOWN TAPE POSITION	W2	0.0		0.7	
LEAD WIRE CLINCH HEIGHT	Ho	A 005200529	16	115000045	± 0.5
COMPONENT HEIGHT	H1		20000	24.0	
LENGTH OF SNIPPED LEADS	L			11.0	
FEED HOLE DIAMETER	Do		4		± 0.2
*5 TOTAL TAPE THICKNESS	t			1.2	
LEAD - TO - LEAD DISTANCE	F1, F2	2.40		2.70	2120
STAND OFF	H2	0.45		1.45	- 0.1
CLINCH HEIGHT	H3			3.0	
LEAD PARALLELISM	C1 - C2			0.22	
PULL - OUT FORCE	(p)	6N			

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- cimum alignment deviation between Is will not to be greater than 0.2mm.
- cimum non-cumulative variation ween tape feed holes shall not eed 1 mm in 20 pitches.
- ddown tape will not exceed beyond edge(s) of carrier tape and there ill be no exposure of adhesive.
- re will be no more than three (3) secutive missing components in a
- ape trailer, having at least three feed es are provided after the last ponent in a tape.
- ices should not interfere with the ocket feed holes.

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- mulative pitch error 1.0 mm/20 pitch
- be measured at bottom of clinch
- op of body
- op of body
- 0.3 0.6 mm

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Customer Notes

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Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



CDIL is a registered Trademark of Continental Device India Limited C-120 Naraina Industrial Area, New Delhi 110 028, India. Telephone + 91-11-2579 6150, 5141 1112 Fax + 91-11-2579 5290, 5141 1119 email@cdil.com www.cdilsemi.com

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